Via First :TSV process machine model

Polish removal

>20um

10um

2um

0um

GNX300B

PNX332B

Productivity 3 platen Polish

Cleaning unit In-line

WSS
・**Non contact measuring**

GDM300
・ **G+P**

GNX300B

・ **High mesh wheel process**

0um 2um 5um 7um 10um **Remain Cu Via height (Exposed)**